

# Global Stacked CMOS Image Sensor Supply, Demand and Key Producers, 2026-2032

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## Abstracts

The global Stacked CMOS Image Sensor market size is expected to reach \$ 12151 million by 2032, rising at a market growth of 10.6% CAGR during the forecast period (2026-2032).

In 2024, global Stack CMOS Image Sensor production reached approximately 1.55 billion Units, with an average global market price of around US\$ 3.65 per unit.

A Stacked CMOS Image Sensor (Stacked CIS) is an upgraded architecture of CMOS image sensor, which realizes higher performance and smaller size by separating and stacking the two core functional modules of the sensor: the pixel array layer (responsible for photoelectric conversion) and the logic circuit layer (responsible for signal processing and readout). It is the mainstream architecture of high-performance CIS in current consumer electronics, automotive, and professional imaging fields.

The CMOS image sensor industry chain presents a vertical hierarchical structure with clear division of labor, spanning from upstream core material and equipment supply, midstream sensor design, manufacturing and packaging, to downstream application terminal integration. The industry has strong technical barriers, high concentration of leading enterprises, and close collaborative links between upstream and downstream links.

### I. Upstream: Core Materials & Equipment (Technical Core, High Barriers)

The upstream segment provides the essential materials, equipment and intellectual property (IP) required for CIS design and manufacturing, and is the foundation of the entire industry chain. The market is dominated by a small number of international enterprises.

#### 1. Core Materials

Semiconductor Wafer Substrate for CIS: chip manufacturing, the most critical material with the highest cost.

Photoresist: Key material for photolithography process, determines pixel precision.

**Metal Target Material:** Used for depositing metal wiring layers (e.g., copper, aluminum).

**Packaging Materials:** Include lead frames, encapsulants, bonding wires, etc.

## 2. Manufacturing Equipment

The equipment accounts for a large proportion of CIS production costs, and the core links are monopolized by overseas enterprises:

**Photolithography Machine:** The core equipment for pixel pattern transfer, directly determines the pixel size and sensor resolution. The leading enterprise is ASML (EUV lithography machines are used for advanced process CIS).

**Etching Equipment:** Used for pattern processing of wafer layers, with representatives such as Applied Materials, Tokyo Electron (TEL).

**Deposition Equipment:** For film deposition of various material layers, leading manufacturers include Applied Materials, TEL.

**Testing Equipment:** Used for performance testing of CIS chips, such as Teradyne, Advantest.

## 3. IP & Design Tools

**IP Authorization:** Core technologies such as pixel structure (BSI/Stacked), global shutter, and HDR algorithms are mostly held by professional IP companies, such as ARM, Synopsys, Cadence.

**EDA Tools:** Essential for CIS circuit design, the market is monopolized by Synopsys, Cadence, and Mentor Graphics.

## II. Midstream: CIS Design, Manufacturing & Packaging (Value Core, High Concentration)

The midstream is the core value link of the industry chain, covering three key links: chip design, wafer fabrication, and packaging and testing. The industry is divided into two business models: IDM (Integrated Device Manufacturer) and Fabless + Foundry + OSAT.

### 1. Chip Design (Fabless/IDM Design Division)

The link determines the technical route and performance parameters of CIS (e.g., pixel structure, resolution, dynamic range). It has high R&D investment and strong technical barriers, and the market concentration is extremely high.

**IDM Mode Enterprises:** Integrate design, manufacturing, packaging and testing, with strong technical strength. Representative enterprises: Sony Semiconductor Solutions, Samsung Electronics, OmniVision (partially self-manufactured).

**Fabless Mode Enterprises:** Focus on design, outsource manufacturing and packaging to third parties. Representative enterprises: On Semiconductor, SK Hynix, GalaxyCore.

### 2. Wafer Fabrication (Foundry)

It is responsible for manufacturing CIS chips according to the design scheme, and the advanced process (e.g., 45nm, 28nm) is the key to improving sensor performance.

Main Foundries: TSMC (the largest foundry, focusing on high-end stacked CIS), UMC, GlobalFoundries, SMIC (focusing on mid-to-low-end CIS process).

IDM Self-Manufacturing Lines: Sony and Samsung have their own advanced wafer factories, which can realize the rapid iteration of proprietary technologies (e.g., Sony's Stacked CMOS).

### 3. Packaging and Testing (OSAT)

The link directly affects the reliability, size and heat dissipation performance of CIS, and the advanced packaging technology is the key to miniaturization and high performance.

Traditional Packaging: Includes wire bonding, encapsulation, etc., suitable for mid-to-low-end CIS, with manufacturers such as ASE Group, Amkor Technology.

Advanced Packaging: Flip-chip packaging (Flip Chip), wafer-level packaging (WLP), chip-scale packaging (CSP) are the mainstream, which can reduce the sensor size and improve the light sensitivity. Leading enterprises: ASE Group, Amkor, STATS ChipPAC.

Testing: Includes wafer testing (CP) and final testing (FT), to ensure the yield and performance consistency of CIS, with manufacturers such as Xcerra, Teradyne.

### III. Downstream: Application Terminal Integration (Demand Core, Diversified Scenarios)

Downstream applications cover consumer electronics, automotive electronics, industrial detection, security monitoring, medical imaging and other fields. The demand of different scenarios drives the iteration of CIS technology, and the B2B field has become the main growth engine in recent years.

#### 1. Consumer Electronics (Traditional Main Market, Gradual Saturation)

Application Scenarios: Smartphones (front and rear cameras), tablets, laptops, digital cameras, drones.

Demand Characteristics: Pursue high resolution (100MP+), small pixel size (0.7 $\mu$ m), stacked structure, but the market growth is slowing down with the saturation of smartphone shipments.

Key Customers: Apple, Samsung, Xiaomi, Huawei, DJI.

#### 2. Automotive Electronics (Fastest Growing Track, High Barriers)

Application Scenarios: Vehicle-mounted cameras (front view, rear view, surround view, in-cabin monitoring), LiDAR supporting sensors, ADAS systems.

Demand Characteristics: Need to meet AEC-Q100 automotive-grade certification, with high requirements for high temperature resistance, anti-electromagnetic interference, high dynamic range (HDR > 120dB) and reliability. The single-vehicle CIS loading quantity can reach 8-16 units with the upgrade of autonomous driving.

Key Customers: Tesla, BYD, Volkswagen, Bosch, Continental.

#### 3. Security Monitoring (Stable Demand, High Performance Requirements)

Application Scenarios: Network cameras (IPC), analog cameras, ball machines, video recorders (NVR).

Demand Characteristics: Emphasize low illumination imaging ability, wide dynamic

range, and night vision effect. 4K high-definition and AI intelligent recognition are the main trends.

Key Customers: Hikvision, Dahua Technology, Uniview.

#### 4. Industrial & Medical Fields (High Profit Margin, Professional Demand)

Industrial Detection: Machine vision cameras, semiconductor detection equipment, barcode scanners, requiring global shutter, high frame rate (thousands of frames/second) and high precision. Key customers: Keyence, Cognex.

Medical Imaging: Endoscopes, dental imaging equipment, portable detectors, requiring high signal-to-noise ratio, low radiation and miniaturization. Key customers: Olympus, Fujifilm.

#### IV. Industry Chain Characteristics & Profit Distribution

Profit Concentration: The upstream equipment and midstream design links occupy the highest profit margin, while the downstream application terminal profit margin is relatively low.

Technical Synergy: The iteration of downstream application demand (e.g., automotive high dynamic range, industrial global shutter) drives the R&D of midstream design and upstream material and equipment technologies, forming a positive feedback loop.

Regional Concentration: The upstream and midstream high-end links are concentrated in Japan, South Korea, the United States and Taiwan of China; the downstream application market is dominated by China, which is the largest CIS consumer market in the world.

This report studies the global Stacked CMOS Image Sensor production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Stacked CMOS Image Sensor and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of Stacked CMOS Image Sensor that contribute to its increasing demand across many markets.

#### **Highlights and key features of the study**

Global Stacked CMOS Image Sensor total production and demand, 2021-2032, (Million Units)

Global Stacked CMOS Image Sensor total production value, 2021-2032, (USD Million)

Global Stacked CMOS Image Sensor production by region & country, production, value, CAGR, 2021-2032, (USD Million) & (Million Units), (based on production site)

Global Stacked CMOS Image Sensor consumption by region & country, CAGR, 2021-2032 & (Million Units)

U.S. VS China: Stacked CMOS Image Sensor domestic production, consumption, key domestic manufacturers and share

Global Stacked CMOS Image Sensor production by manufacturer, production, price,

value and market share 2021-2026, (USD Million) & (Million Units)

Global Stacked CMOS Image Sensor production by Type, production, value, CAGR, 2021-2032, (USD Million) & (Million Units)

Global Stacked CMOS Image Sensor production by Application, production, value, CAGR, 2021-2032, (USD Million) & (Million Units)

This report profiles key players in the global Stacked CMOS Image Sensor market based on the following parameters - company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include SONY, Samsung, OmniVision, STMicroelectronics, On Semi, GalaxyCore, SOI, Smartsens Technology, Canon, etc. This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Stacked CMOS Image Sensor market

**Detailed Segmentation:**

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (Million Units) and average price (US\$/Unit) by manufacturer, by Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

Global Stacked CMOS Image Sensor Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

### Global Stacked CMOS Image Sensor Market, Segmentation by Type:

12MP

26MP

Others

### Global Stacked CMOS Image Sensor Market, Segmentation by Stacking Layer Count:

2?Stack CIS

3?Stack CIS

Multi?Stack CIS (?4 layers)

### Global Stacked CMOS Image Sensor Market, Segmentation by Bonding Technology:

Micro?bump Bonding

Cu?Cu Hybrid Bonding

Through?Silicon Vias (TSV) Bonding

### Global Stacked CMOS Image Sensor Market, Segmentation by Application:

Mobile Phone

Automobile

Others

### **Companies Profiled:**

SONY

Samsung

OmniVision

STMicroelectronics

On Semi

GalaxyCore

SOI

Smartsens Technology

Canon

**Key Questions Answered:**

1. How big is the global Stacked CMOS Image Sensor market?
2. What is the demand of the global Stacked CMOS Image Sensor market?
3. What is the year over year growth of the global Stacked CMOS Image Sensor market?
4. What is the production and production value of the global Stacked CMOS Image Sensor market?
5. Who are the key producers in the global Stacked CMOS Image Sensor market?
6. What are the growth factors driving the market demand?

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